

L80 Hardware Design

GNSS Module Series

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About the Document

Revision History

Version	Date	Author	Description
1.0	2013-07-25	Tony GAO	Initial
1.1	2013-08-10	Tony GAO	 Modified the voltage range of VCC pin. Added AADET_N pin in Figure 1 Block Diagram, and the description of it in Table 3. Modified the description about power supply in Chapter 3.3. Optimized the mechanical dimensions about the height in Figure 18. Modified the structure of Chapter 4. Added content in Chapter 4.3 about how to judge the antenna status via AADET_N pin.
1.2	2014-06-11	Tony GAO	 Modified the input power at EX_ANT. Updated packaging information.
1.3	2015-11-09	Neil WU	 Added the description of FLP mode. Added the description of PPS VS. NMEA. Added note for the position of pin 1. Modified the PCB design guide.
1.4	2016-04-22	Neil WU	Modified the PCB design guide.
1.5	2020-04-29	Andy ZHAO	 Updated the description about the backup mode in Chapter 3.4.3. Added the description about the power-on sequence of the module in Chapter 3.5. Modified the module thickness in Chapter 6.1, and VCC and V_BCKP voltage ranges in Chapter 3.2.



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1 Introduction

This document defines and specifies L80 GPS module. Hardware interfaces, external application reference circuits, mechanical size and air interface of L80 module are described in this document.

This document helps customers quickly understand the interface specifications, as well as electrical and mechanical details of L80 module. Other documents such as L80 software application notes and user guides are also provided for customers, so that the customers can use L80 module to design and set up applications quickly.

1.1. Safety Information

The following safety precautions must be observed during all phases of operation, such as usage, service or repair of any terminal incorporating Quectel L80 module. Manufacturers of the terminal should notify users and operating personnel of the following safety information by incorporating these guidelines into all manuals supplied with the product. If not so, Quectel assumes no liability for customers' failure to comply with these precautions.



Ensure the use of the product conforms to the local safety and environment regulations, and is allowed in the country and the environment required.



Keep away from explosive and flammable materials. The use of electronic products in extreme power supply conditions and locations with potentially explosive atmospheres may cause fire and explosion accidents.



The product must be powered by a stable voltage source, and the wiring shall conform to security precautions and fire prevention regulations.



Proper ESD handling procedures must be followed throughout the mounting, handling and operation of any application that incorporates the module to avoid ESD damages.



2 Description

2.1. General Description

L80 GPS module equipped with an embedded patch antenna (15 mm \times 15 mm \times 4 mm) and LNA brings high performance of MTK positioning engine to the industrial applications. With a small-footprint leadless package, the L80 GPS module makes it possible to implement the top level of sensitivity, accuracy and TTFF in the industry with the minimum power consumption. By using 66 search channels and 22 simultaneous tracking channels, the L80 GPS module can track and find satellites within the shortest time even when the signal is at a signal-challenging environment. An embedded flash memory is used to store useful navigation data and perform updates in the future.

L80 module is integrated with advanced features such as EASY, AIC, LOCUS, AlwaysLocate[™], FLP, and Antenna Supervisor. These features can help shorten TTFF, improve sensitivity, reduce power consumption and detect antenna status in the GPS system. The module supports various positioning, navigation and industrial applications such as autonomous GPS, SBAS (including WAAS, EGNOS, MSAS, and GAGAN), QZSS, and AGPS.

By using the L80 module equipped with the embedded patch antenna and LNA, the design of the device can be simplified and the costs of the device can be reduced. Moreover, in addition to an automatic antenna switching function with which switching between an external active antenna and the internal patch antenna can be implemented, the L80 module also supports external active antenna detection and short circuit protection. The detection result and notification of different external active antenna statuses will be included in the NMEA message consisting of external active antenna connection, open circuit for antenna and antenna short-circuit. In this way, a host can query the external active antenna status in a timely and convenient manner.

As the key feature of the L80 module, the EASY technology is one type of AGPS. Being capable of obtaining and processing all internal aiding information such as GPS time, Ephemeris and Last Position, the GPS module provides a very short TTFF at a hot or warm start.

The L80 module is an SMD type module with a compact 16 mm \times 16 mm \times 6.95 mm form factor. The module can be built in applications by using the 12 pins at 2.54 mm pitch spacing. The L80 module provides necessary hardware interfaces for connections to the main PCB.

The module is fully compliant to EU RoHS regulations.



2.2. Key Features

Table 1: Key Features

Features	Implementation			
Power Supply	Supply voltage: 2.8–4.3 V, typ. 3.3 V			
Power Consumption	 Acquisition: 25 mA @ VCC = V_BCKP = 3.3 V Tracking: 20 mA @ VCC = V_BCKP = 3.3 V Standby: 1.0 mA @ VCC = V_BCKP = 3.3 V Backup: 7 µA @ V_BCKP = 3.3 V 			
Receiver Type	 GPS L1 1575.42 MHz C/A Code 66 search channels, 22 simultaneous tracking channels 			
Sensitivity	 Acquisition: –148 dBm Re-acquisition: –160 dBm Tracking: –165 dBm 			
TTFF (EASY enabled)	 Cold start: typ. 15 s @ -130 dBm Warm start: typ. 5 s @ -130 dBm Hot start: typ. 1 s @ -130 dBm 			
TTFF (EASY disabled)	 Cold start (Autonomous): typ. 35 s @ -130 dBm Warm start (Autonomous): typ. 30 s @ -130 dBm Hot start (Autonomous): typ. 1 s @ -130 dBm 			
Horizontal Position Accuracy (Autonomous)	● < 2.5 m CEP @ −130 dBm			
Max Update Rate • Up to 10 Hz, 1 Hz by default				
Accuracy of 1PPS Signal	Typical accuracy: ±10 nsTime pulse width 100 ms			
Velocity Accuracy	Without aid: 0.1 m/s			
Acceleration Accuracy	Without aid: 0.1 m/s²			
Dynamic Performance	 Maximum altitude: 18,000 m Maximum velocity: 515 m/s Acceleration: 4 G 			
UART Port	 UART Port: TXD1 and RXD1 Supports baud rate from 4800 bps to 115200 bps, where the default setting is 9600 bps UART port is used for NMEA output, MTK proprietary commands input and firmware upgrade 			
Temperature Range	 Normal operation: -40 °C to +85 °C Storage temperature: -45 °C to +125 °C 			



Physical Characteristics

Size: $16 \pm 0.15 \text{ mm} \times 16 \pm 0.15 \text{ mm} \times 6.95 \pm 0.1 \text{ mm}$

Weight: Approx. 6.0 g

NOTES

- The power consumption is measured in the open air with internal patch antenna. Meanwhile, EASY, AIC and SBAS are enabled.
- 2. If the external active antenna is used, VCC pin will supply power for external active antenna. The typical additional current consumption is approximately 11 mA @ 3.3 V.
- 3. The performance of external active antenna is similar to that of internal patch antenna expect for power consumption.

2.3. Block Diagram

The following figure shows a block diagram of L80 module. It consists of a single chip GPS IC which includes the RF part and Baseband part, a SPDT, a patch antenna, a LNA, a SAW filter, a TCXO, a crystal oscillator, short protection and antenna detection circuit for active antenna.

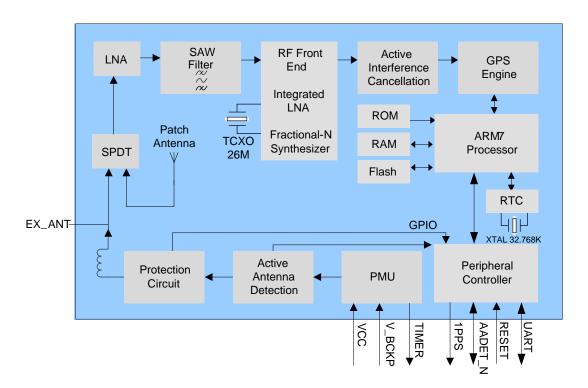


Figure 1: Block Diagram



2.4. Evaluation Board

To help customers apply L80 module to applications of the customers, Quectel provides an evaluation board (EVB) with micro USB serial cable and other peripherals to test the module.

For more details, please refer to the document [1].

2.5. Protocols Supported by the Module

Table 2: Protocols Supported by the Module

Protocol	Туре	
NMEA	Output, ASCII, 0183, 3.01	
PMTK	Input, MTK proprietary protocol	



Please refer to the *document [2]* for details of NMEA standard protocol and MTK proprietary protocol.



3 Application

The module is equipped with 12 LCC pins with 2.54 mm pitch that are connected to customer applications. Interfaces of the pins are described in detail in the following chapters.

3.1. Pin Assignment



Figure 2: Pin Assignment



3.2. Pin Definition

Table 3: Pin Description

Power Supply						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
VCC	4	I	Main power supply	Vmax = 4.3 V Vmin = 2.8 V Vnom = 3.3 V	Supply current no less than 100mA.	
V_BCKP	5	I	Backup power supply	Vmax = 4.3 V Vmin = 2 V Vnom = 3.3 V	Supply power for RTC domain. The V_BCKP pin can be directly powered by battery or connected to VCC.	
Reset						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
RESET	10	I	System reset	$V_{IL}min = -0.3 \text{ V}$ $V_{IL}max = 0.8 \text{ V}$ $V_{IH}min = 2.0 \text{ V}$ $V_{IH}max = 3.6 \text{ V}$	Low level active. If unused, keep this pin open or connect it to VCC.	
UART Port						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
RXD1	1	I	Receive data	$V_{IL}min = -0.3 \text{ V}$ $V_{IL}max = 0.8 \text{ V}$ $V_{IH}min = 2.0 \text{ V}$ $V_{IH}max = 3.6 \text{ V}$		
TXD1	2	0	Transmit data	V_{OL} min = -0.3 V V_{OL} max = 0.4 V V_{OH} min = 2.4 V V_{OH} max = 3.1 V		
RF Interface	RF Interface					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
EX_ANT	11	I	External active antenna RF input	Characteristic impedance of 50 Ω	If unused, keep this pin open.	
Other Interfaces						



Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
1PPS	6	0	One pulse per second	V_{OL} min = -0.3 V V_{OL} max = 0.4 V V_{OH} min = 2.4 V V_{OH} max = 3.1 V	Synchronized at rising edge, the pulse width is 100 ms. If unused, keep this pin open.
TIMER	7	0	An open drain output signal can be used to control GPS module main power on/off	$V_{OL}min = -0.3 \text{ V}$ $V_{OL}max = 0.4 \text{ V}$ $V_{OH}min = 1.1 \text{ V}$ $V_{OH}max = 3.1 \text{ V}$	It belongs to RTC domain. If unused, keep this pin open or connect to Ground externally.
AADET_N	8	I/O	Active antenna detection	$V_{OL}max = 0.7 V$ $V_{OH}min = 1.3 V$	If unused, keep this pin open. Refer to <i>Chapter 4.3</i> .

3.3. Power Supply

VCC pin supplies power for BB, RF, I/O, LNA, short protection and antenna detection circuit. The load current of VCC varies depending on the VCC level, processor load, the number of tracked satellites and the rate of satellite re-acquisition. Using external active antenna will consume additional 11mA from our module. Therefore, it is important to supply sufficient current and ensure that the power is clean and stable. VCC supply ripple voltage should meet the requirement: max. 54 mV (RMS) @ f = 0...3 MHz and max. 15 mV (RMS) @ f > 3 MHz. Customers should choose the LDO without a built-in output high-speed discharge function to keep long output voltage drop-down period. The decouple combination of 10 μ F and 100 nF capacitor is recommended nearby VCC pin.

The V_BCKP pin supplies power for RTC domain. It should be valid when the module is powered on. The voltage of RTC domain ranges from 2 V to 4.3 V. In order to achieve a better TTFF, RTC domain should be valid all the time. It can supply power for SRAM memory in RTC domain which contains all the necessary GPS information for quick start-up and a small amount of user configuration variables.

The module's internal power construction is shown below.

VCC supplies power for PMU, and V_BCKP supplies power for RTC domain. TIMER signal highlighted in red in the following figure belongs to RTC domain and can be used to turn on/off the power switch.



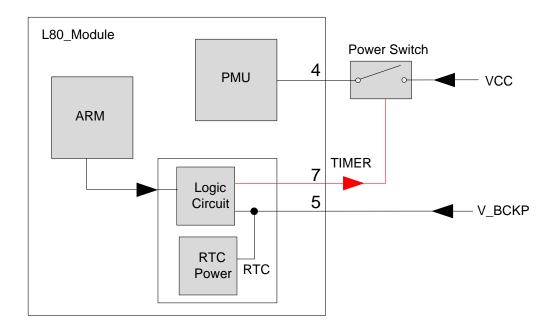


Figure 3: Internal Power Construction

Power supply solutions for L80 module are as follows:

The simplest power circuit for L80 module is 3.3 V power source connected to VCC pin and V_BCKP pin of the module directly. In this case, once the module is powered on, the full cold start will be implemented.

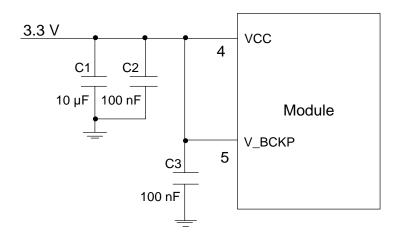


Figure 4: Reference Circuit for Power Supply

NOTE

If the design mentioned above is applied to a power supply circuit, L80 module does not support EASY technology and backup mode as well as other modes related to it, e.g. AlwaysLocateTM backup mode.



- The other way is feeding V_BCKP through a backup battery directly. The module will enter backup mode when power source (3.3 V) is cut off. Furthermore, it is necessary to add an external charging circuit for rechargeable battery. The detailed schematic diagram (mount R2 with 0 Ω to replace power switch) is shown below. Note that the capacity of backup battery should be large enough to maintain V_BCKP valid as there is no charge source when power source (3.3 V) is cut off. MS621FE FL11E from Seiko is recommended. The consumption of V_BCKP is as low as 7 µA in backup mode.
- A power switch circuit can also be applied to replace R2 when it matches with TIMER pin. In this way, the module will not only support backup mode but also support periodic backup mode and AlwaysLocate™ backup mode. The schematic with power supply circuit is shown below. As power source (3.3 V) is always valid and the battery is charged continuously, the capacity of the battery can be small. The detailed schematic for power switch circuit is shown in Figure 6.

For more details about backup mode, periodic backup mode and AlwaysLocate[™] backup mode, please refer to the related chapters.

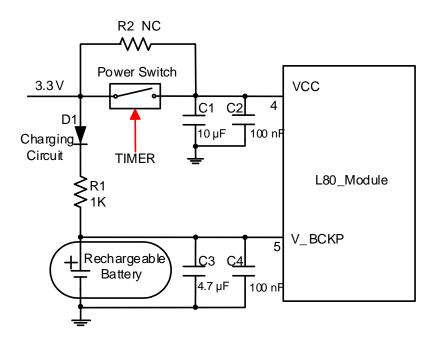


Figure 5: Reference Charging Circuit for Rechargeable Battery

NOTE

VCC does not supply power for RTC domain in L80 module, and therefore the V_BCKP pin must be powered externally. Furthermore, it is strongly recommended to supply power to V_BCKP through a backup battery, which can ensure L80 module supports EASY technology and improves TTFF after next restart. For details about TTFF, please refer to *Chapter 2.2*.



3.4. Operating Modes

The table below briefly illustrates the relationship among different operating modes of L80 module.

Table 4: Module States Switch

Current Mode	Next Mode						
	Backup	Standby	Full on	Periodic	AlwaysLocate	FLP	
Backup	N/A	N/A	Refer to Chapter 3.4.3	N/A	N/A	N/A	
Standby	N/A	N/A	Send any data via UART	N/A	N/A	N/A	
Full on	Refer to Chapter 3.4.3	PMTK161	N/A	PMTK225	PMTK225	PMTK262	
Periodic	N/A	N/A	Refer to Chapter 3.4.4	N/A	N/A	N/A	
Always Locate	N/A	N/A	Refer to Chapter 3.4.5	N/A	N/A	N/A	
FLP	N/A	N/A	Refer to Chapter 3.4.6	N/A	N/A	N/A	

NOTE

For more details about MTK proprietary protocol, please refer to the document [2].

3.4.1. Full on Mode

Full on mode includes tracking mode and acquisition mode. Acquisition mode is defined as the mode in which the module starts searching satellites and determining visible satellites, coarse carrier frequency and code phase of satellite signals. When the acquisition is completed, it switches to tracking mode automatically. Tracking mode is defined as the mode in which the module keeps tracking satellites and demodulates the navigation data from the specific satellites.

When the combination of VCC and V_BCKP is valid, the module will enter full on mode automatically and follow the default configurations as below. For more details, refer to *Chapter 3.3* about internal power construction. PMTK commands may be used to change the configurations to satisfy particular requirements.



Table 5: Default Configurations

Item	Configuration	Comment
Baud Rate	9600 bps	
Protocol	NMEA	RMC, VTG, GGA, GSA, GSV, GLL and GPTXT (MTK proprietary protocol)
Update Rate	1 Hz	
SBAS	Enable	
AIC	Enable	
LOCUS	Disable	
EASY	Enable	EASY will be disabled automatically when update rate exceeds 1 Hz.

3.4.2. Standby Mode

Standby mode is a low-power-consumption mode. In the standby mode, the internal core and I/O power domain are still active, but RF and TCXO are powered off, and the module stops satellite search and navigation. UART is still accessible through PMTK commands or any other data, but there is no NMEA messages output.

Sending PMTK command "\$PMTK161,0*28" will make L80 module enter standby mode. Sending any data via UART can wake the module up. When the module exits from standby mode, it will use all internal aiding information like GPS time, Ephemeris, Last Position, etc., resulting to the fastest possible TTFF in either Hot or Warm start. The typical standby current consumption in this way is about 1 mA @ VCC = 3.3 V

NOTE

When the external active antenna is used, an additional 11 mA will be consumed because the VCC still supplies power for external active antenna in standby mode.

3.4.3. Backup Mode

Less power is consumed in the backup mode compared with that consumed in the standby mode. In this mode, only the backup supply V_BCKP is powered on while the main supply VCC is disconnected through the host or the TIMER signal of L80. In order to enter backup mode autonomously via the TIMER pin, an external switch circuit is necessary. The following figure shows a typical reference design specific



to the switch circuit for TIMER.

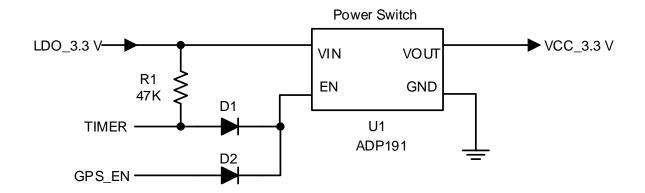


Figure 6: The External Switch Circuit for TIMER

NOTES

- 1. U1 is an integrated power switch component. The part number ADP191 is recommended. U1 can also be replaced by discrete components. Please refer to the *document [3]* for more details.
- 2. TIMER pin can also be used to control the EN pin of an LDO.
- 3. TIMER and GPS_EN signals form an "OR" logic via the Schottky diodes D1 and D2. GPS_EN is a GPIO signal coming from the host.
- 4. TIMER is an open drain output signal. When TIMER pin is used, please pull it high by using an external resistor. R1 is the pull-up resistor for TIMER signal.

Keeping GPS_EN signal low and sending PMTK command \$\pmax\$PMTK225,4*2F" will make L80 module enter backup mode forever. When this command is executed successfully, TIMER signal will be pulled down to turn off the power switch, so L80 module can go into backup mode as the main power VCC is cut off. For this case, pulling the GPS_EN signal high by host is the only way to wake the module up.

The specific operation steps of entering the backup mode are as follows:

- 1. Supply power to the VCC pin later than the V_BCKP pin, where the module is working normally.
- 2. Cut off the power supply for the the VCC pin, so that the module enters backup mode, where the current measured at V_BCKP pin is the current in backup mode.

The typical current value in the backup mode is 7 μ A. If customers directly supply power to the V_BCKP pin in the shutdown state without performing the foregoing steps, the module will enter an unstable state and the current will exceed the nominal value.



The following timing diagram indicates that the module enters backup mode after being powered on.

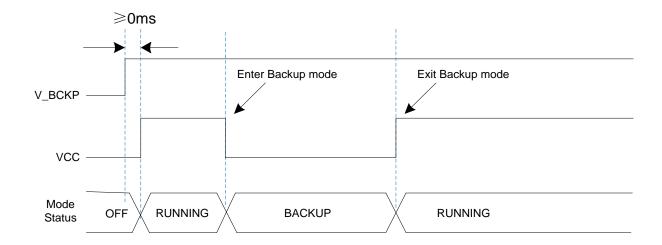


Figure 7: Backup Mode Sequence Diagram

In backup mode, L80 module stops acquiring and tracking satellites. UART is not accessible. But the backed-up memory in RTC domain which contains all the necessary GPS information for quick start-up and a small amount of user configuration variables is alive. Due to the backed-up memory, EASY technology is available.

As the main power supply for V_BCKP pin is battery. Coin-type rechargeable capacitor such as MS920SE from Seiko can be used and Schottky diode such as RB520S30T1G from ON Semiconductor is recommended to be used here for its low voltage drop.

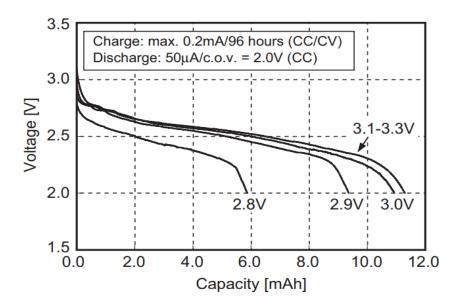


Figure 8: Seiko MS920SE Charge and Discharge Characteristics



3.4.4. Periodic Mode

Periodic mode is a mode of switching between the full on mode and standby/backup mode periodically to reduce power consumption. It contains periodic standby mode and periodic backup mode.

The format of the command which enables the module to enter periodic mode is as follows:

Table 6: PMTK Command Format

Format: \$PMTK225, <type>,< CR><lf></lf></type>	-Run_time>, <sleeμ< th=""><th>o_time>,<2nd_run_time>,<2nd_sleep_time>*<checksum><</checksum></th></sleeμ<>	o_time>,<2nd_run_time>,<2nd_sleep_time>* <checksum><</checksum>
Parameter	Format	Description
Туре	Decimal	Type=1 for periodic backup mode Type=2 for periodic standby mode
Run_time	Decimal	Full on mode period (ms)
Sleep_time	Decimal	Standby/Backup mode period (ms)
2nd_run_time	Decimal	Full on mode period (ms) for extended acquisition in case GPS module's acquisition fails during the Run_time
2nd_sleep_time	Decimal	Standby/Backup mode period (ms) for extended sleep in case GPS module's acquisition fails during the Run_time
Checksum	Hexadecimal	Hexadecimal checksum

Example

\$PMTK225,1,3000,12000,18000,72000*16<CR><LF>
\$PMTK225,2,3000,12000,18000,72000*15<CR><LF>

Sending "\$PMTK225,0*2B" in any time will make the module enter full on mode from periodic standby mode.

Sending "\$PMTK225,0*2B" just in **Run_time** or **2nd_run_time** can make the module enter full on mode from periodic backup mode.

NOTES

- 1. The precondition is that the external switch circuit supports periodic backup mode. For details, please refer to *Chapter 3.4.3.*
- 2. Before entering into periodic backup mode, please ensure the GPS_EN signal is low and power supply for V_BCKP is alive.



The following figure shows the operation of periodic mode. When receiving PMTK command, the module will be in the full on mode firstly. After several minutes, the module will enter the periodic mode and follow the manually set parameters. When the module fails to fix the position in **Run_time**, the module will switch to **2nd_run_time** and **2nd_sleep_time** automatically. As long as the module fixes the position again, the module will return to **Run_time** and **Sleep_time**.

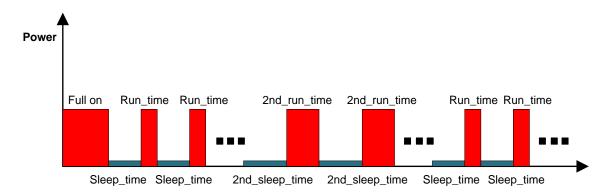


Figure 9: Periodic Mode

Please ensure that the module is in the tracking state before entering into periodic mode. Otherwise, the module will be at the risk of failure to track the satellites. If GPS module is located in weak signal environment, it is better to set a longer **2nd_run_time** to ensure the success of re-acquisition.

The average current value can be calculated by the following formula:

$$I_{periodic} = (I_{tracking} \times T1 + I_{standby/backup} \times T2) / (T1 + T2)$$

(T1: Run_time, T2: Sleep_time)

Example

PMTK225,2,3000,12000,18000,72000*15 for periodic mode with 3s in tracking mode and 12s in standby mode. The average current consumption is calculated below:

$$I_{periodic} = (I_{tracking} \times T1 + I_{standby} \times T2) / (T1 + T2) = (20 \text{ mA} \times 3 \text{ s} + 1 \text{ mA} \times 12 \text{ s}) / (3 \text{ s} + 12 \text{ s}) \approx 4.8 \text{ (mA)}$$

PMTK225,1,3000,12000,18000,72000*16 for periodic mode with 3s in tracking mode and 12s in backup mode. The average current consumption is calculated below:

$$I_{periodic} = (I_{tracking} \times T1 + I_{backup} \times T2) / (T1 + T2) = (20 \text{ mA} \times 3 \text{ s} + 0.007 \text{ mA} \times 12 \text{ s}) / (3 \text{ s} + 12 \text{ s}) \approx 4.0 \text{ (mA)}$$

3.4.5. AlwaysLocate™ Mode

AlwaysLocate[™] is an intelligent power saving mode. It contains AlwaysLocate[™] backup mode and AlwaysLocate[™] standby mode.

AlwaysLocateTM standby mode allows the module to switch automatically between full on mode and



standby mode. According to the environmental and motion conditions, the module can adaptively adjust the full on time and standby time to achieve a balance between positioning accuracy and power consumption. The returning of "\$PMTK001,225,3*35" from the module in response to the sent "\$PMTK225,8*23" indicates that the module accesses AlwaysLocateTM standby mode successfully. This mode will facilitate power saving. Sending "\$PMTK225,0*2B" in any time will return the module to the full on mode.

AlwaysLocateTM backup mode is similar to AlwaysLocateTM standby mode. The difference is that in AlwaysLocateTM backup mode, switching between full on mode and backup mode can be performed automatically. The PMTK command to enter AlwaysLocateTM backup mode is "\$PMTK225,9*22".The module can exit from AlwaysLocateTM backup mode by command "\$PMTK225,0*2B" sent just after the module has been waked up from previous backup cycle.

The positioning accuracy in AlwaysLocateTM mode will be decreased, especially at high speed. The following figure shows the power consumption of L80 module in different daily scenes when AlwaysLocateTM mode is enabled.

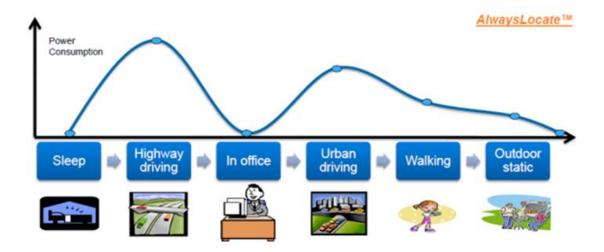


Figure 10: AlwaysLocate™ Mode

Example

The typical average consumption is about 3.5 mA in AlwaysLocate[™] standby mode and 3.0 mA in AlwaysLocate[™] backup mode.

NOTES

- 1. Power consumption is measured under outdoor static mode with patch antenna. Using external active antenna will increase the power consumption.
- 2. Before entering into periodic backup mode, please ensure the GPS_EN signal is low and power supply for V_BCKP is alive.



3.4.6. FLP Mode

The Fitness Low Power (FLP) feature provides low power GPS solution for fitness application. FLP is a duty cycle concept to achieve low power target. It is specifically designed for walking/running/cycling applications.

FLP function is disabled by default. FLP can be enabled by using SDK or PMTK command. Sending "\$PMTK262,1*29" will enable FLP function, and wait until L80 module gets a valid fix. Then wait at least 60s for L80 to enter FLP mode. FLP function will be disabled after sending "\$PMTK262,0*28". For more details, please refer to the *document [4]*.

Table 7: Average Current for FLP Mode and Tracking Mode of L80

Scenario	In FLP Mode (mA)	In Tracking Mode (mA)
Static	11.3	20
Walking	10.9	20
Running	10.7	20
Driving	11.4	20

NOTES

- 1. The EASY and FLP function cannot work at the same time. When FLP by SDK or PMTK command is enabled, the EASY function will be disabled automatically.
- 2. SBAS data downloading will be influenced by FLP function. It is suggested that customers should disable the SBAS while enabling FLP mode.
- 3. The power consumption is measured in the open sky under different states of motion.
- 4. The current is the average of multiple measurements.



3.5. Power on

Power is supplied to the VCC pin and the V_BCKP pin in sequence to power on the L80 module. After being powered on, the module outputs the NMEA message through the serial port. The power-on sequence diagram is shown below.

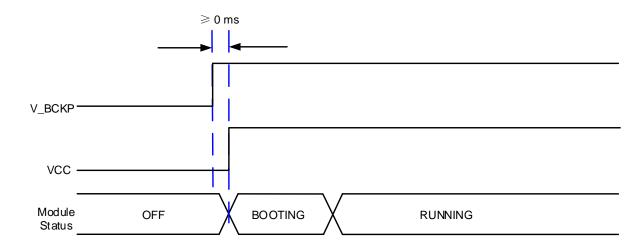


Figure 11: Power-on Timing

3.6. Reset

L80 module can be restarted by driving RESET pin to a low level voltage for a certain time and then releasing it. This operation will reset the digital part of the GPS receiver. It should be noted that non-volatile backup RAM is not cleared after resetting and therefore a short TTFF is possible. An OC driver circuit shown below is recommended to control the RESET pin.

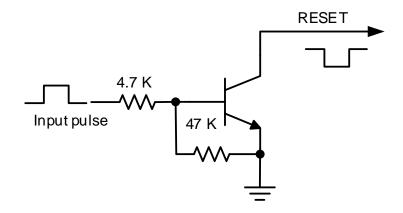


Figure 12: Reference Reset Circuit Using OC Circuit



The restart timing of L80 has been illustrated bellow.

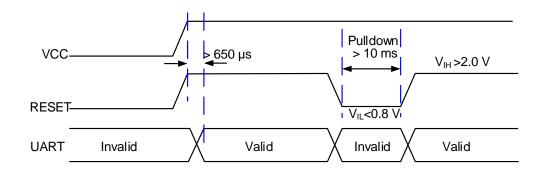


Figure 13: Restart Timing

3.7. UART Interface

The module provides one universal asynchronous receiver & transmitter serial port. The module is designed as DCE (Data Communication Equipment), following the traditional DCE-DTE (Data Terminal Equipment) connection. The module and the client (DTE) are connected through the signals shown in the following figure. It supports data baud rates from 4800 bps to 115200 bps.

UART port:

- TXD1: Send data to the RXD signal line of DTE.
- RXD1: Receive data from the TXD signal line of DTE.

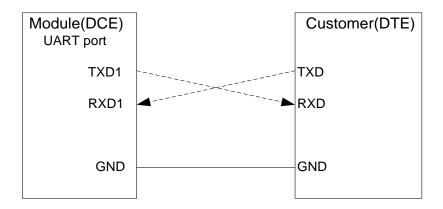


Figure 14: Connection of Serial Interfaces



This UART port has the following features:

- UART port can be used for firmware upgrade, NMEA output and PMTK proprietary commands input.
- The default output NMEA type setting is RMC, VTG, GGA, GSA, GSV, GLL and GPTXT (MTK proprietary protocol).
- UART port supports the following baud rates:
 4800 bps, 9600 bps, 14400 bps, 19200 bps, 38400 bps, 57600 bps, 115200 bps.
 The default setting is 9600 bps, 8 bits, no parity bit, 1 stop bit.
- Hardware flow control and synchronous operation are not supported.

The UART port does not support the RS-232 level but only CMOS level. If the module's UART port is connected to the UART port of a computer, it is necessary to add a level shift circuit between the module and the computer. Please refer to the following figure.

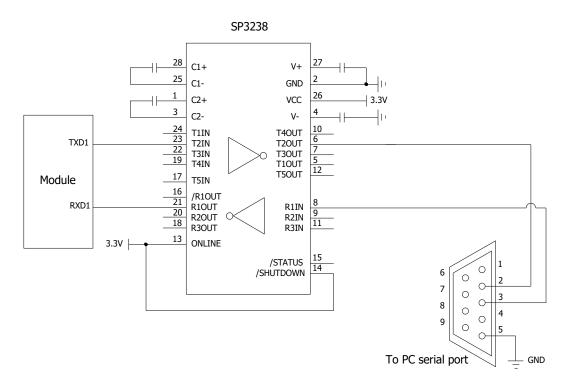


Figure 15: RS-232 Level Shift Circuit

3.8. EASY Technology

EASY technology works as embedded software which can accelerate TTFF by predicting satellite navigation messages from received ephemeris. The GPS engine will calculate and predict orbit information automatically up to 3 days after first receiving the broadcast ephemeris, and then save the predicted information into the internal memory. GPS engine will use the information for positioning if no enough information from satellites, so the function is helpful for positioning and TTFF improvement.



The EASY function can reduce TTFF to 5 seconds in warm start. In this case, RTC domain should be valid. In order to get enough broadcast ephemeris information from GPS satellites, the GPS module should receive the information for at least 5 minutes in good signal conditions after fixing the position.

EASY function is enabled by default. Command "\$PMTK869,1,0*34" can be used to disable EASY. For more details, please refer to the *document* [2].

3.9. Multi-tone AIC

L80 module provides an advanced technology called multi-tone AIC (Active Interference Cancellation) to reject RF interference which comes from other active components on the main board.

Up to 12 multi-tone AIC embedded in the module can provide effective narrow-band interference and jamming elimination. The GPS signal could be recovered from the jammed signal, which can ensure better navigation quality. AIC is enabled by default, closing it will save about 1 mA @ VCC = 3.3 V consumption. The following commands can be used to set AIC:

Enable AIC function: "\$PMTK 286,1*23".

Disable AIC function: "\$PMTK 286,0*22".

3.10. LOCUS

L80 module supports the embedded logger function called LOCUS. It can log position information to the internal flash memory automatically when this function is enabled by sending PMTK command "\$PMTK185, 0*22". Due to this function, the host can enter the sleep mode to reduce power consumption and does not need to keep receiving the NMEA information all the time. The module can provide a log capacity of more than 16 hours.

The detailed procedures of this function are illustrated bellow:

- The module has fixed the position (only 3D_fixed is available);
- Sending PMTK command "\$PMTK184,1*22" to erase internal flash;
- Sending PMTK command "\$PMTK185,0*22" to start log;
- Module logs the basic information (UTC time, latitude, longitude and height) every 15 seconds to internal flash memory;
- Stop logging the information by sending "\$PMTK185,1*23";
- Host can get the data from the module via UART by sending "\$PMTK622,1*29".

The raw data which host gets has to be parsed via LOCUS parser code provided by Quectel. For more details, please contact Quectel technical supports.



3.11. Antenna Supervisor

Antenna Supervisor is designed to detect different external active antenna status including external active antenna connection, open circuit for antenna and antenna short-circuited, and then notify the module. The detections and notifications of external active antenna are listed in the following table.

Table 8: Status of the Antenna

Status of the Antenna	EXT/Patch	NMEA Message
External Active Antenna is not Inserted	Patch	OPEN
External Active Antenna is Inserted and Worked Normally	EXT	OK
External Active Antenna is Inserted but Short-circuited	Patch	SHORT

3.12. PPS VS. NMEA

Pulse per Second (PPS) VS. NMEA can be used in time service. The latency range of the beginning of UART Tx is between 170 ms and 180 ms, and behind the rising edge of PPS.

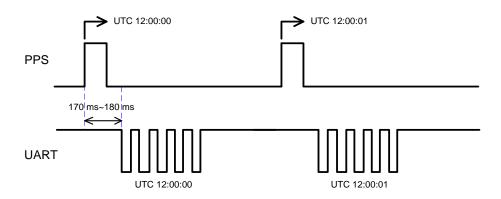


Figure 16: PPS VS. NMEA Timing

This feature only supports 1 Hz NMEA output and baud rate of 14400–115200 bps. At baud rate of 9600 and 4800 bps, it only supports RMC NMEA sentence. Because at low baud rate, per second transmission may exceed one second if there are many NMEA sentences output. This function can be enabled by sending "\$PMTK255,1*2D", and the function can be disabled by sending "\$PMTK255,0*2C".



4 Antenna Interfaces

L80 module receives L1 band signal from GPS satellites at a nominal frequency of 1575.42 MHz. The LNA is embedded for better performance. It is an ultra-compact module with embedded 15.0 mm \times 15.0 mm \times 4.0 mm patch antenna. In addition, L80 can also support external active antenna, and the RF signal is obtained from the EX_ANT pin. Both internal patch signal and external active antenna signal are intelligently switched through SPDT.

4.1. Internal Patch Antenna

4.1.1. 15×15×4 Patch Antenna

The quality of the embedded GPS antenna is crucial to the overall sensitivity of the GPS system. L80 offers an on-module patch antenna. A 15.0 mm × 15.0 mm × 4.0 mm high-performance patch antenna is chosen for reducing product size. This antenna is specially designed for satellite reception applications, and it has excellent stability and sensitivity to consistently provide high signal reception efficiency. The specification of the antenna used by L80 is described in following table.

Table 9: Antenna Specification for L80 Module with Ground Plane 100 mm × 60 mm

Antenna Type	Parameter	Specification	Notes
Patch Antenna	Size	15.0 mm × 15.0 mm × 4.0 mm	
	Range of Receiving Frequency	1575.42 ±1.023 MHz	
	Impendence	50 Ω	
	Bandwidth	Min. 10 MHz	Return Loss ≤ -10 dB
	Frequency Temperature Coefficient (TF)	0 ±20 ppm/°C	–40 °C to +85 °C
	Polarization	RHCP	Right Hand Circular Polarization
	Gain at Zenith	Typ. 3.4 dBi	Contro fraguency
	VSWR	Max. 1.5	Centre frequency



Axial ratio Max. 3 dB

The test result of the antenna is shown in the following figure. This embedded GPS antenna provides good radiation efficiency, right hand circular polarization and optimized radiation pattern. The antenna is insensitive to surroundings and has high tolerance against frequency shifts.

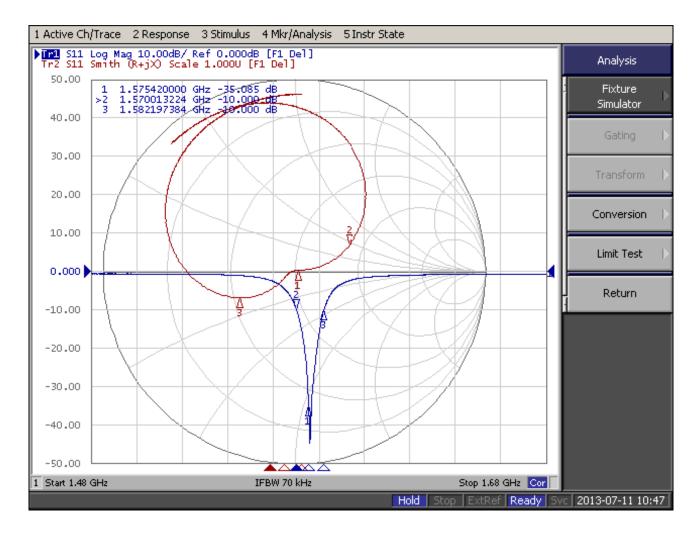


Figure 17: Patch Antenna Test Result with Ground Plane 100 mm × 60 mm

4.1.2. PCB Design Guide

The radiation characteristic of antenna depends on various factors, such as the size, shape of the PCB and the dielectric constant of components nearby. It is recommended to follow the rules listed below.

• Keep the module at least 5 mm away from the nearest edge of the motherboard, that is, it is better to be placed in the center of the motherboard.



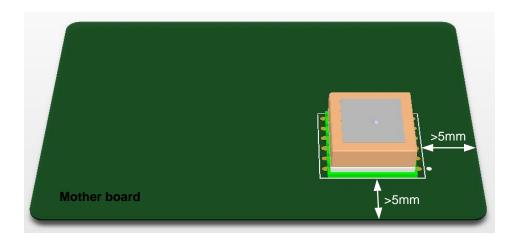


Figure 18: Recommended Distance between Module and Motherboard Edges

• The position on the motherboard corresponding to the feed point of the patch antenna should be kept out on each layer, and the diameter of the keepout area should not be less than 2.5 mm.

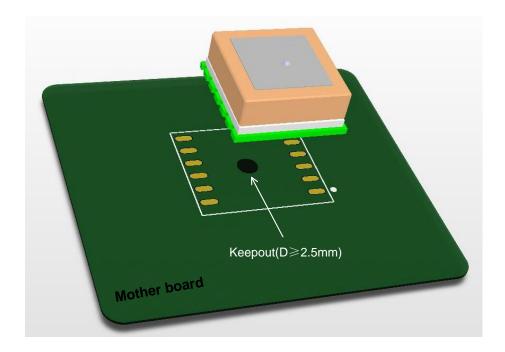


Figure 19: Recommended Treatment for the Feed Point of the Patch Antenna

- Make sure the antenna points to the sky.
- The performance of embedded patch antenna depends on the actual size of the ground plane around the module. It is recommended to design a 30 mm x 30 mm ground plane shown below. In addition, components, especially thick ones, cannot be placed in the areas in any case (interfering vias are not allowed either).



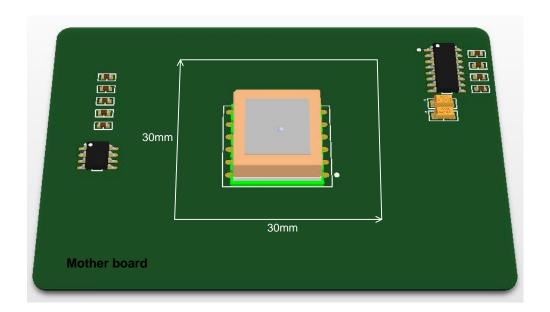


Figure 20: Recommended Ground Plane

• Keep the patch antenna at least 10 mm away from other tall metal components. Otherwise, the antenna performance will be affected.

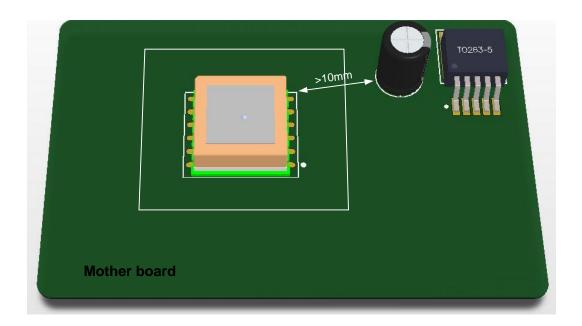
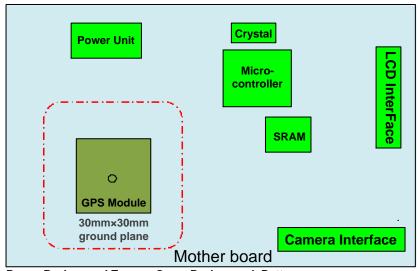


Figure 21: Recommended Distance between Module and Tall Metal Components

 Make sure the microcontroller, crystal, LCD, camera and other high-speed components and interfaces are placed on the opposite side of the module, and keep them away from the module as far as possible, such as in diagonal position of the motherboard.





Brown Background:Top Green Background: Bottom

Figure 22: Recommended Placement of GNSS Module

- Make sure interfering signals (USB, LCD, Camera, Crystal, etc.) are on inner layer and shielded by ground plane, and keep them and their vias far away from the module.
- Make sure RF system such as BT/WIFI/GSM is on the opposite side of the module, and keep them
 away from the module as far as possible, such as in diagonal position of the board.

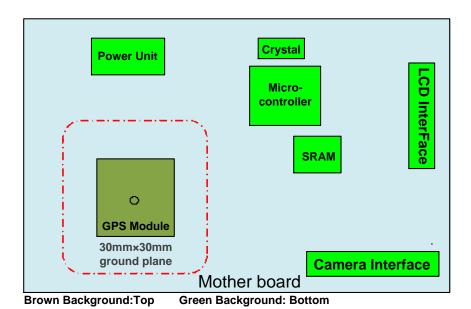


Figure 23: Recommended Placement of GNSS Module with the RF System

- Keep DCDC far away from the module.
- Device enclosure should be made of non-metal materials especially for those which are around antenna area. The minimum distance between antenna and enclosure is 3 mm.
- The RF part of GPS module is sensitive to temperature. Please keep them away from heat-emitting



circuit.

• It is recommended to reserve an integrate ground layer to isolate GPS module from others.

4.2. External Active Antenna

The following figure is a typical reference design with active antenna. In this mode, DC on the EX_ANT pin is powered by VCC and supplies power to the external active antenna.

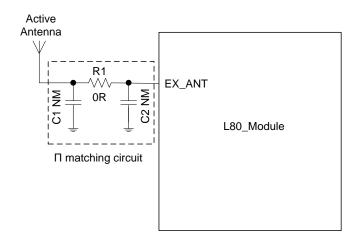


Figure 24: Reference Design for Active Antenna

C1, R1, C2 are reserved matching circuit for antenna impedance modification. By default, C1 and C2 are not mounted; R1 is 0 Ω . In this mode, R1 must not be capacitance, as current will stream through R1 to the active antenna. C1 and C2 must not be inductance or resistance to avoid short circuit.

The impedance of RF trace line in main PCB should be controlled as 50 Ω , and the trace length should be kept as short as possible.

Table 10: Recommended Active Antenna Specification

Antenna Type	Specification	
	Center frequency: 1575.42 MHz	
	Band width: > 5 MHZ	
	VSWR: typ. < 2	
A chi va A raha rana	Polarization: RHCP or Linear	
Active Antenna	Noise figure: < 1.5 dB	
	Gain (antenna): > -2 dBi	
	Gain (embedded LNA): typ. 20 dB	
	Total gain: typ. > 18 dBi	



NOTE

To ensure effective short protection function, please select a DC-open (DC-impedance between the SMA's inner signal needle and outside ground) GPS active antenna. The DC-impedance can also be measured with a common and simple multimeter on few samples, and the value is generally in M Ω level.

4.3. Antenna Status Indicator

L80 module supports automatic antenna switching function. The GPTXT sentence can be used to identify the status of external active antenna.

If **ANTSTATUS=OPEN**, it means external active antenna is not connected or has poor contact with antenna feeding point and the internal antenna is used.

If ANTSTATUS=OK, it means external active antenna is connected and the module will use external active antenna.

If **ANTSTATUS=SHORT**, it means active antenna is short circuited and the internal patch antenna will be used automatically.

NOTES

- 1. When customers use external active antenna and the "OPEN" is displayed in the GPTXT of NMEA sentence, customers have to check the connection status of external active antenna.
- If the external active antenna is short-circuited, the "SHORT" will be displayed in the GPTXT of NMEA sentence.
- 3. Because antenna short protection is enabled by default, L80 will switch to embedded patch antenna automatically in case that external active antenna is short-circuited, which will avoid L80 from damage. Meanwhile, customers need to check the external active antenna.



Example

"OPEN" is displayed in the GPTXT sentence below.

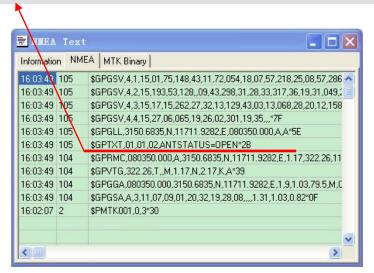


Figure 25: Patch Antenna Status Description in GPSTXT

Table 11: GPTXT — Status of Antenna

GPTXT Display	Ext Active Antenna Status	Inner Patch Antenna Status	Attention
OPEN	Unused	Working	Customers need to check the external active antenna status if the active antenna is used.
OK	Working	Unused	
SHORT	Short	Working	Please check the external active antenna

The pin "AADET_N" can also be used to indicate the status of active antenna. When active antenna is not connected to EX_ANT or has poor contact with antenna feeding point, AADET_N will keep a high level to indicate the absence of active antenna. AADET_N will change to a low level when active antenna is connected well.

NOTE

Active antenna is ONLY available when the voltage of AADET_N is less than or equal to 0.7 V.



5 Electrical, Reliability and Radio Characteristics

5.1. Absolute Maximum Ratings

Absolute maximum ratings for power supply and voltage on digital pins of the module are listed in the following table.

Table 12: Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
Power Supply Voltage (VCC)	-0.3	5.0	V
Backup Battery Voltage (V_BCKP)	-0.3	5.0	V
Input Voltage at Digital Pins	-0.3	3.6	V
Input Power at EX_ANT		15	dBm
Storage Temperature	– 45	125	°C

NOTE

When in a condition with parameters exceeding the "absolute maximum ratings", the device may be permanently damaged. The product is not protected against overvoltage or reversed voltage. Thus, it is necessary to utilize appropriate protection diodes to keep voltage spikes within the parameters given in the table above.



5.2. Operating Conditions

Table 13: Power Supply Ratings

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
VCC	Supply voltage	Voltage must stay within the min/max values, including voltage drop, ripple, and spikes.	2.8	3.3	4.3	V
Ivccp	Peak supply current	VCC = 3.3V			100	mA
V_BCKP	Backup voltage supply		2	3.3	4.3	V
TOPR	Normal operating temperature		-40	25	85	°C

NOTES

- 1. The figure I_{VCCP} can be used to determine the maximum current capability of power supply.
- 2. Operation beyond the "Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect the device's reliability.

5.3. Current Consumption

The values for current consumption are shown in the following table.

Table 14: Current Consumption

Parameter	Conditions	Min.	Тур.	Max.	Unit
I _{VCC} @ Acquisition	$VCC = V_BCKP = 3.3V$		25		mA
I _{VCC} @ Tracking	VCC = V_BCKP = 3.3V		20		mA
I _{VCC} @ Standby	VCC = V_BCKP = 3.3V		1.0		mA
I _{BCKP} @ Backup	V_BCKP = 3.3V		7		μΑ



NOTES

- 1. The tracking current is tested in the following conditions:
- At Cold Start, 10 minutes after First Fix.
- At Hot Start, 15 seconds after First Fix.
- 2. For the backup mode current consumption test, please refer to Chapter 3.4.3.

5.4. Electrostatic Discharge

L80 module is an ESD sensitive device. ESD protection precautions should still be emphasized. Proper ESD handling and packaging procedures must be followed throughout the processing, handling and operation of any application.

The ESD bearing capability of the module is listed in the following table. Note that customers should add ESD components to module pins in particular applications.

Table 15: ESD Endurance Table (Temperature: 25 °C, Relative Humidity: 45%)

Pin	Contact Discharge	Air Discharge
EX_ANT	±5 kV	±10 kV
Patch Antenna	±5 kV	±10 kV
VCC	±5 kV	±10 kV
UART	±3 kV	±6 kV
Others	±2 kV	±4 kV

5.5. Reliability Test

Table 16: Reliability Test

Test Item	Conditions	Standard
Thermal Shock	-30 °C to +80 °C, 144 cycles	GB/T 2423.22-2002 Test Na IEC 68-2-14 Na
Damp Heat, Cyclic	+55 °C; > 90% RH 6 cycles for 144 hours	IEC 68-2-30 Db Test



Vibration Shock	5–20 Hz, 0.96 m ² /s ³ ; 20–500 Hz, 0.96	2423.13-1997 Test Fdb
VIDIALION SHOCK	m ² /s ³ -3 dB/oct, 1 hour/axis; no function	IEC 68-2-36 Fdb Test
Heat Test	%5 %C 2 hours approximal	GB/T 2423.1-2001 Ab
пеаттем	85 °C, 2 hours, operational	IEC 68-2-1 Test
Cold Test	-40 °C, 2 hours, operational	GB/T 2423.1-2001 Ab
Cold lest		IEC 68-2-1 Test
Heat Soak	00.90 72 have non-on-retional	GB/T 2423.2-2001 Bb
пеат Зоак	90 °C, 72 hours, non-operational	IEC 68-2-2 Test B
Cold Soak	45 °C 72 hours non aparational	GB/T 2423.1-2001 A
Culu Suak	-45 °C, 72 hours, non-operational	IEC 68-2-1 Test



6 Mechanical Dimensions

This chapter describes the mechanical dimensions of the module.

6.1. Mechanical Dimensions of the Module

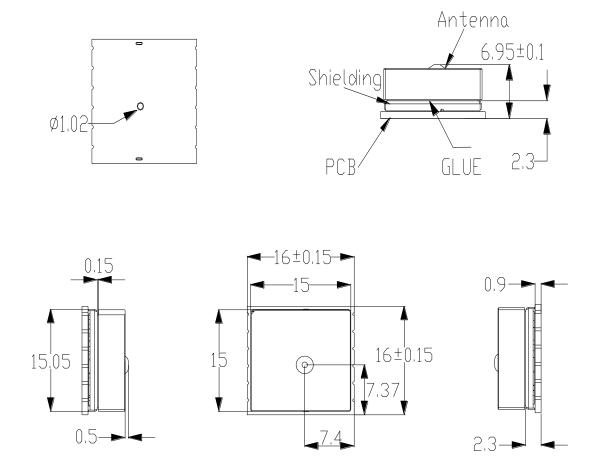


Figure 26: Mechanical Dimensions (Unit: mm)



6.2. Bottom View Dimensions and Recommended Footprint

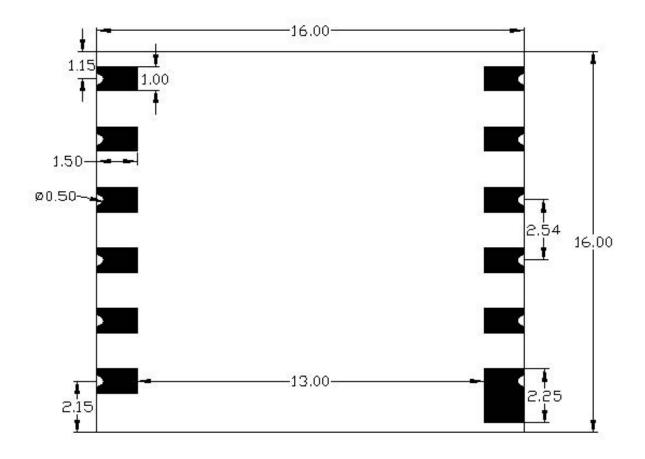


Figure 27: Bottom View Dimensions (Unit: mm)



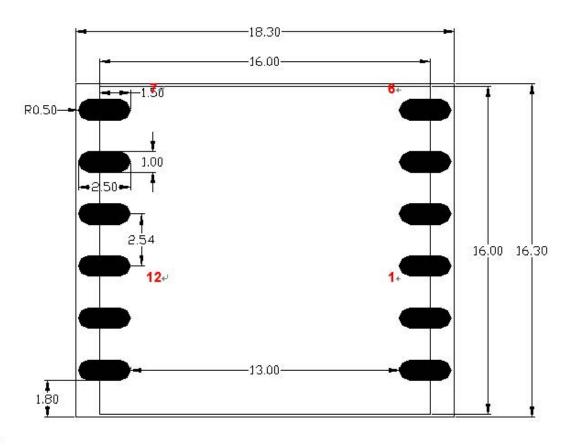


Figure 28: Recommended Footprint (Unit: mm)

NOTE

For easy maintenance, please keep a distance of no less than 3 mm between the module and other components on the motherboard.



6.3. Top and Bottom Views of the Module

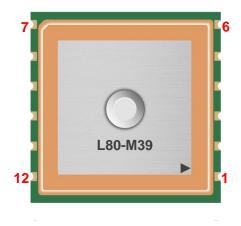


Figure 29: Top View of the Module

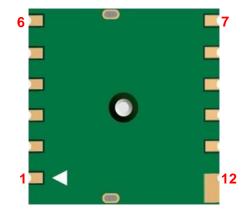


Figure 30: Bottom View of the Module

NOTES

- 1. The chamfer of the patch antenna does not indicate the position of pin 1.
- 2. These are rendering drawings of L80 module. For authentic appearance, please refer to the module from Quectel.



7 Manufacturing, Packaging and Ordering Information

7.1. Storage

L80 module is provided with vacuum-sealed packaging. MSL of the module is rated as 3. The storage requirements are shown below.

- 1. Recommended Storage Condition: The temperature should be 23 ±5 °C and the relative humidity should be 35%–60%
- 2. The storage life (in vacuum-sealed packaging) is 12 months in Recommended Storage Condition.
- 3. The floor life of the module is 24 hours in a plant where the temperature is 23 ±5 °C and relative humidity is below 60%. After the vacuum-sealed packaging is removed, the module must be processed in reflow soldering or other high-temperature operations within 24 hours. Otherwise, the module should be stored in an environment where the relative humidity is less than 10% (e.g. a drying cabinet).
- 4. The module should be pre-baked to avoid blistering, cracks and inner-layer separation in PCB under the following circumstances:
 - The module is not stored in Recommended Storage condition;
 - Violation of the third requirement above occurs;
 - Vacuum-sealed packaging is broken, or the packaging has been removed for over 24 hours;
 - Before module repairing.
- 5. If needed, the pre-baking should follow the requirements below:
 - The module should be baked for 8 hours at 120 ±5 °C;
 - All modules must be soldered to PCB within 24 hours after the baking, otherwise they should be put in a dry environment such as in a drying oven.



NOTE

Please take the module out of the packaging and put it on high-temperature resistant fixtures before the baking. If shorter baking time is desired, please refer to *IPC/JEDEC J-STD-033* for baking procedure.

7.2. Manufacturing and Soldering

Push the squeegee to apply the solder paste on the surface of stencil, so that the paste fills the stencil openings and then penetrate to the PCB. The force on the squeegee should be adjusted properly so as to produce a clean stencil surface on a single pass. To ensure the module soldering quality, the thickness of stencil for the module is recommended to range from 0.15 mm to 0.18 mm. For more details, please refer to *document* [5].

It is suggested that the peak reflow temperature ranges from 238–246 °C, and the absolute maximum reflow temperature is 246 °C. To avoid damage to the module caused by repeated heating, it is strongly recommended that the module should be mounted after reflow soldering for the other side of PCB has been completed. The recommended reflow soldering thermal profile (lead-free reflow soldering) and related parameters are shown below.

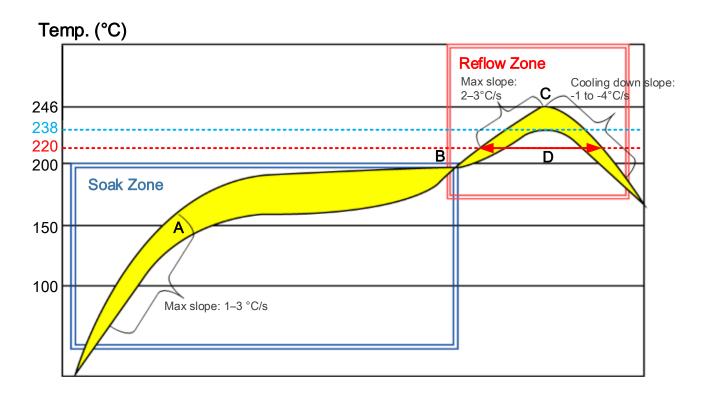


Figure 31: Recommended Reflow Soldering Thermal Profile



Table 17: Recommended Thermal Profile Parameters

Factor	Recommendation
Soak Zone	
Max slope	1–3 °C/s
Soak time (between A and B: 150°C and 200°C)	70–120 s
Reflow Zone	
Max slope	2–3 °C/s
Reflow time (D: over 220°C)	45–70 s
Max temperature	238–246 °C
Cooling down slope	-1 to -4 °C/s
Reflow Cycle	
Max reflow cycle	1

NOTES

- 1. During manufacturing and soldering, or any other processes that may contact the module directly, NEVER wipe the module's shielding can with organic solvents, such as acetone, ethyl alcohol, isopropyl alcohol, trichloroethylene, etc. Otherwise, the shielding can may become rusted.
- 2. The shielding can for the module is made of Cupro-Nickel base material. It is tested that after 12 hours' Neutral Salt Spray test, the laser engraved label information on the shielding can is still clearly identifiable and the QR code is still readable, although white rust may be found.

7.3. Packaging

The modules are stored inside a vacuum-sealed bag under ESD protection. It should not be opened until the devices are ready to be soldered onto the application.



7.3.1. Tape and Reel Packaging

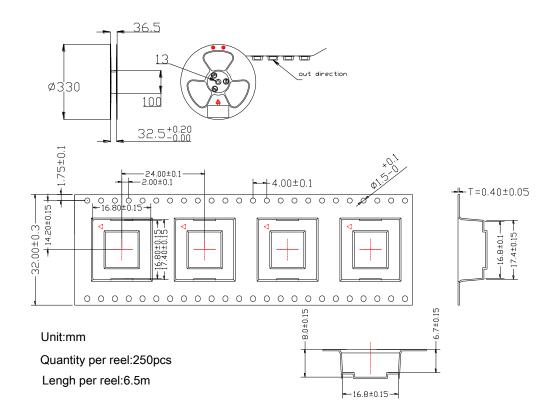


Figure 32: Tape and Reel Specifications (Unit: mm)

Table 18: Reel Packaging

Model Name	MOQ for MP	Minimum Package: 250 pcs	Minimum Package x 4 = 1000 pcs
L80	250pcs	Size: 370 mm × 350 mm × 56 mm N.W: 1.5 kg G.W: 2.25 kg	Size: 380 mm × 250 mm × 365 mm N.W: 6.1 kg G.W: 9.4 kg

7.4. Ordering Information

Table 19: Ordering Information

Model Name	Ordering Code
L80	L80-M39



8 Appendix A References

Table 20: Related Documents

SN	Document Name	Remark
[1]	Quectel_L80_EVB_User Guide	L80 EVB user guide
[2]	Quectel_L80_GPS_Protocol_Specification	L80 GPS protocol specification
[3]	Quectel_L80_Reference_Design	L80 reference design
[4]	Quectel_GNSS_SDK_Commands_Manual	GNSS SDK commands manual
[5]	Quectel_Module_Secondary_SMT_Application_Note	Secondary SMT user guide for Quectel modules

Table 21: Terms and Abbreviations

Abbreviation	Description
AGPS	Assisted GPS
AIC	Active Interference Cancellation
CEP	Circular Error Probable
DGPS	Differential GPS
EASY	Embedded Assist System
EGNOS	European Geostationary Navigation Overlay Service
EPO	Extended Prediction Orbit
ESD	Electrostatic Discharge
GPS	Global Positioning System
GNSS	Global Navigation Satellite System
GGA	GPS Fix Data



GLL	Geographic Position—Latitude/Longitude
GLONASS	Global Navigation Satellite System
GSA	GNSS DOP and Active Satellites
GSV	GNSS Satellites in View
HDOP	Horizontal Dilution of Precision
I/O	Input/Output
Inom	Nominal Current
Imax	Maximum Load Current
Kbps	Kilo Bits Per Second
LNA	Low Noise Amplifier
MSAS	Multi-functional Satellite Augmentation System
MSL	Moisture Sensitive Level
MOQ	Minimum Order Quantity
NMEA	National Marine Electronics Association
PDOP	Position Dilution of Precision
PMTK	MTK Proprietary Protocol
PPS	Pulse Per Second
PRN	Pseudo Random Noise Code
QZSS	Quasi-Zenith Satellite System
RHCP	Right Hand Circular Polarization
RMC	Recommended Minimum Specific GNSS Data
SBAS	Satellite-based Augmentation System
SAW	Surface Acoustic Wave
SPDT	Single-Pole Double-Throw
TTFF	Time To First Fix
UART	Universal Asynchronous Receiver & Transmitter



VDOP	Vertical Dilution of Precision
VTG	Course over Ground and Ground Speed, Horizontal Course and Horizontal Velocity
Vmax	Maximum Voltage Value
Vnom	Nominal Voltage Value
Vmin	Minimum Voltage Value
V _{IH} max	Maximum Input High Level Voltage Value
V _{IH} min	Minimum Input High Level Voltage Value
V _{IL} max	Maximum Input Low Level Voltage Value
V _{IL} min	Minimum Input Low Level Voltage Value
V _I max	Absolute Maximum Input Voltage Value
V _I min	Absolute Minimum Input Voltage Value
V _{OH} max	Maximum Output High Level Voltage Value
V _{OH} min	Minimum Output High Level Voltage Value
V _{OL} max	Maximum Output Low Level Voltage Value
V _{OL} min	Minimum Output Low Level Voltage Value
WAAS	Wide Area Augmentation System